

PCN # 1968

DATE: December 20, 2021

EXPECTED PCN SHIP DATE: December 20, 2021



Quality Assurance  
160 Rio Robles  
San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE  
 PRODUCT CHANGE NOTICE

ANALOG DEVICES HEREBY ISSUES NOTIFICATION OF CHANGE  
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN     WAFER FAB     ASSEMBLY     TEST     ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: For ADI devices MAX6035 (Precision Voltage Reference ICs) Current wafer fabrication process HV3NKM3 (6-inch wafer size) at ADI's Beaverton/Oregon foundry (MFN)	CHANGE TO: - Move to process H38NKM3 (8-inch wafer size) at same ADI's Beaverton/Oregon foundry (MFN)
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JUSTIFICATION: -  
 Due to tool capacity constraint for the 6-inch HV3NKM3 process, ADI is moving to the 8-inch H38NKM3 process to ensure adequate capacity for supply continuity and long term sustainability.  
 ADI has achieved equivalency between the two processes.  
 H38NKM3 process reliability qualification report is attached (MFN\_H38NKM3\_R40984)  
 The wafer fabrication location remains the same.  
 The Form/Fit/Function of the devices is unchanged.

TRACEABILITY: Analog Device maintains full traceability by device marking, packaging labels and shipment documents.

Analog Devices's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

*Nasser Ali Chaouche*

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Analog Devices Company Representative    or    Nasser AliChaouche, PCN Coordinator  
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